

# APPLICATION MANUAL

## Negative-input Negative-output Regulator IC TK721xxCS

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# Negative-input Negative-output Regulator IC TK721xxCS

## 1. DESCRIPTION

TK721xxCS series is a negative-input negative-output regulator IC using silicon monolithic bipolar structure which can supply 150mA output current. The output voltage can be set from -2.0 to -9.5V, which is trimmed in high accuracy. TK721xxCS is supplied with ON/OFF terminal and noise reduction terminal. The ON/OFF control can be controlled directly with positive logic or CPU. Moreover, TK721xxCS is provided with short-circuit protection and thermal shutdown.

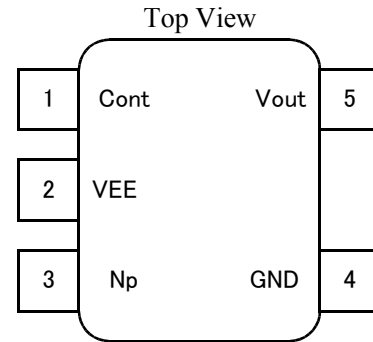
## 2. FEATURES

- High Output Voltage Accuracy( $\pm 2.0\%$  or  $\pm 60$  mV)
- ON/OFF control available (High OFF)
- Built-in short-circuit protection and thermal shutdown.
- Guarantee 150mA output current(200mA peak)
- Ceramic capacitor available for application

## 3. APPLICATIONS

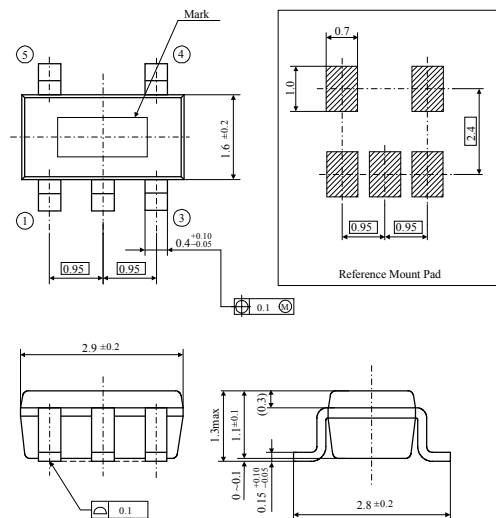
- Battery Powered Systems
- DSC, CCD bias, GaAs bias.

## 4. PIN CONFIGURATION

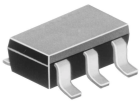


## 5. PACKAGE OUTLINE

- SOT23-5

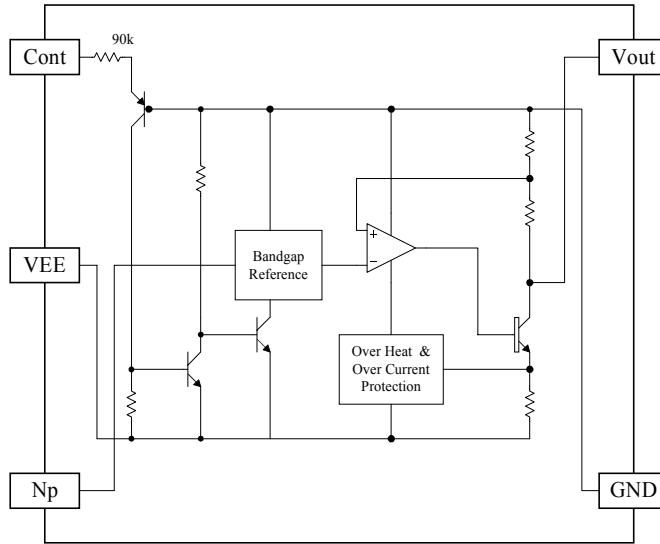


**5. ORDERING INFORMATION**

Package	Vout	Part Number	Marking
SOT23-5 	-2.0	TK72120CS	K20
	-2.5	TK72125CS	K25
	-3.0	TK72130CS	K30
	-3.5	TK72135CS	K35
	-4.0	TK72140CS	K40
	-4.5	TK72145CS	K45
	-5.0	TK72150CS	K50
	-5.5	TK72155CS	K55
	-6.0	TK72160CS	K60
	-6.5	TK72165CS	K65
	-7.0	TK72170CS	K70
	-7.5	TK72175CS	K75
	-8.0	TK72180CS	K80
	-8.5	TK72185CS	K85
	-9.0	TK72190CS	K90
	-9.5	TK72195CS	K95

For other voltages, please contact the TOKO sales office.

**6. BLOCK DIAGRAM**



Control:Low Level On

**7. ABSOLUTE MAXIMUM RATINGS**

T<sub>a</sub>=25°C

Parameter	Symbol	Rating	Units	Conditions
Supply Voltage	V <sub>in</sub>	-20	V	V <sub>in</sub>  + V <sub>cont</sub>  ≤20V
Control pin Voltage	V <sub>cont</sub>	-0.4 ~ +5	V	V <sub>in</sub>  + V <sub>cont</sub>  ≤19V
Power Dissipation				
(SOT23-5 Simple substance)	P <sub>D</sub>	500	mW	P <sub>D</sub> must be decreased at the rate of 4mW/°C for operation above 25°C.
Storage Temperature Range	T <sub>stg</sub>	-55 ~ +150	°C	
Operating Temperature Range	T <sub>OP</sub>	-40 ~ 85	°C	
Operating Voltage Range	V <sub>OP</sub>	-19	V	V <sub>in</sub>  + V <sub>cont</sub>  ≤19V
Output short-circuit current	I <sub>short</sub>	300	mA	Over Current Protection

Absolute maximum ratings are limits beyond which damage to the device may occur. When the operation exceeds this standard, quality can not be guaranteed.

**8. ELECTRICAL CHARACTERISTICS**

Vin=Vout<sub>TYP</sub>-1.5V, Ta=25°C

Parameter	Symbol	Value			Unit	Condition
		MIN	TYP	MAX		
Vout	Vout	Refer to TABLE 1			V	Iout=5mA
Line Regulation	LinReg		1	5	mV	ΔVin=5V
Load Regulation	LoaReg	Refer to TABLE 1			mV	Iout=5mA~50mA
		Refer to TABLE 1			mV	Iout=5mA~100mA
		Refer to TABLE 1			mV	Iout=5mA~150mA
Dropout Voltage *1	Vdrop		0.29	0.50	V	Iout=50mA
			0.48	0.80	V	Iout=100mA
			0.66	1.10	V	Iout=150mA
Supply Current	Icc		155	250	μA	Iout=0mA
Standby Current	Istandby		20	60	μA	Vout Off State
Peak Output Current	Iout <sub>PEAK</sub>	200	280		mA	When Vout drops 10%
Control Current	Icont		12	30	μA	Vcont=+1.8V
Control Voltage	Vcont	0		0.3	V	Vout ON State
		1.5			V	Vout OFF State

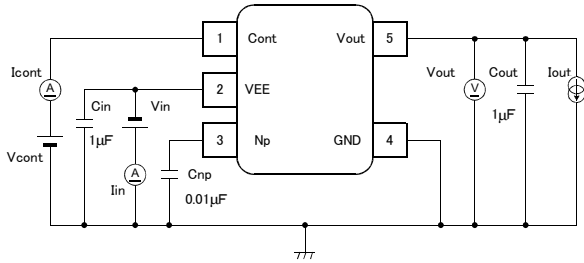
\*1 For Vout≥-3.0 no regulations

**TABLE 1**

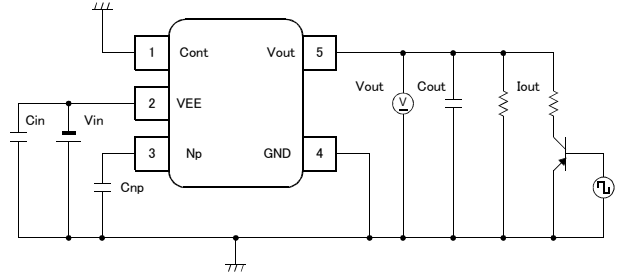
Part Number	Vout			LoaReg					
				Iout=50mA		Iout=100mA		Iout=150mA	
	MIN	TYP	MAX	TYP	MAX	TYP	MAX	TYP	MAX
TK72120CS	-2.060	-2.000	-1.940	9	24	15	39	24	60
TK72125CS	-2.560	-2.500	-2.440	9	24	15	39	24	60
TK72130CS	-3.060	-3.000	-2.940	9	24	15	39	24	60
TK72135CS	-3.570	-3.500	-3.430	11	28	18	46	28	70
TK72140CS	-4.080	-4.000	-3.920	12	30	20	52	32	80
TK72145CS	-4.590	-4.500	-4.410	14	34	23	59	36	90
TK72150CS	-5.100	-5.000	-4.900	15	38	25	65	40	100
TK72155CS	-5.610	-5.500	-5.390	17	41	28	72	44	110
TK72160CS	-6.120	-6.000	-5.880	18	45	30	78	48	120
TK72165CS	-6.630	-6.500	-6.370	20	49	33	85	52	130
TK72170CS	-7.140	-7.000	-6.860	21	53	35	91	56	140
TK72175CS	-7.650	-7.500	-7.350	23	56	38	98	60	150
TK72180CS	-8.160	-8.000	-7.840	24	60	40	104	64	160
TK72185CS	-8.670	-8.500	-8.330	26	64	43	111	68	170
TK72190CS	-9.180	-9.000	-8.820	27	68	45	117	72	180
TK72195CS	-9.690	-9.500	-9.310	29	71	48	124	76	190

**9. TEST CIRCUIT**

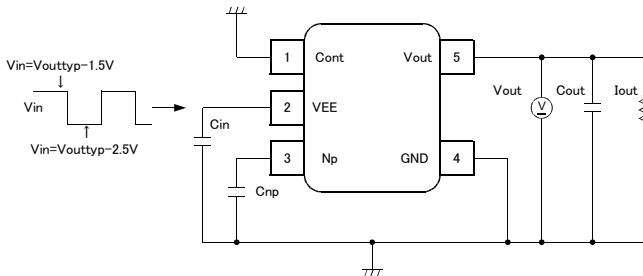
**■ DC**



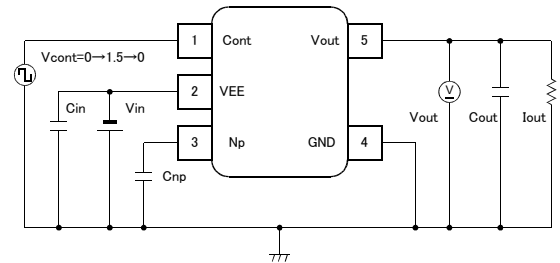
**■ Load Transient**



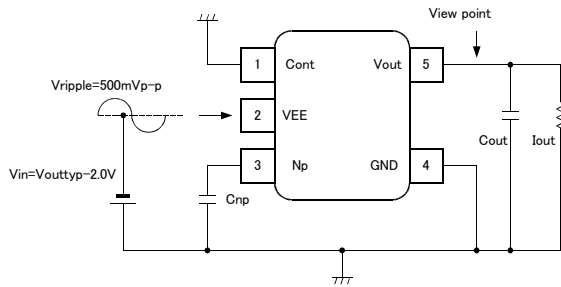
**■ Line Transient**



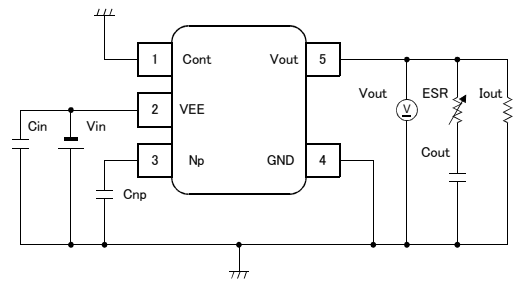
**■ ON/OFF Transient**



**■ Ripple Rejection**



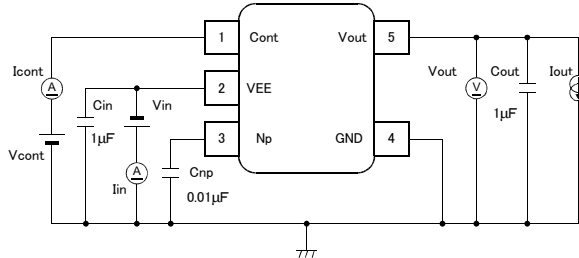
**■ ESR Stability**



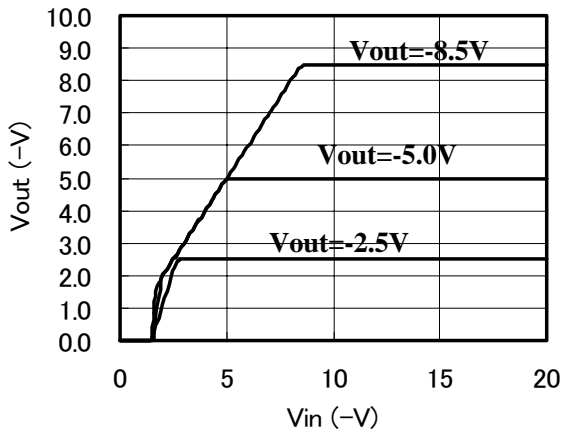
**10. TYPICAL CHARACTERISTICS**

**10-1 DC CHARACTERISTICS**

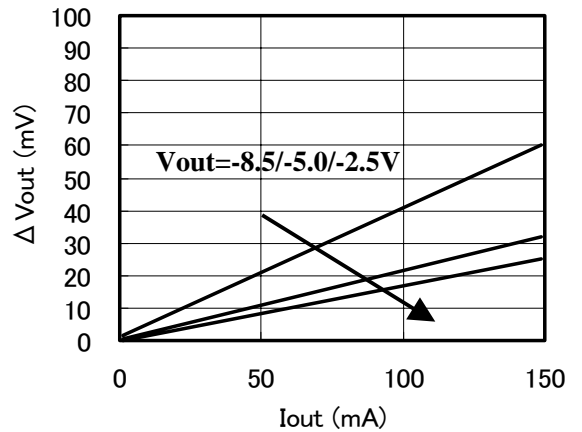
Unless otherwise specified  $V_{in}=V_{out\_TYP}-1.5V$ ,  $V_{cont}=0V$ ,  $C_{in}=1.0\mu F(MLCC)$ ,  $C_{out}=1.0\mu F(MLCC)$ ,  $C_{np}=0.01\mu F$ ,  $T_a=25^\circ C$



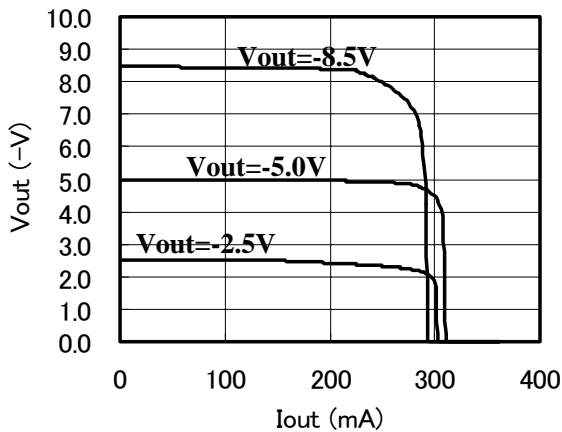
■ Line Regulation



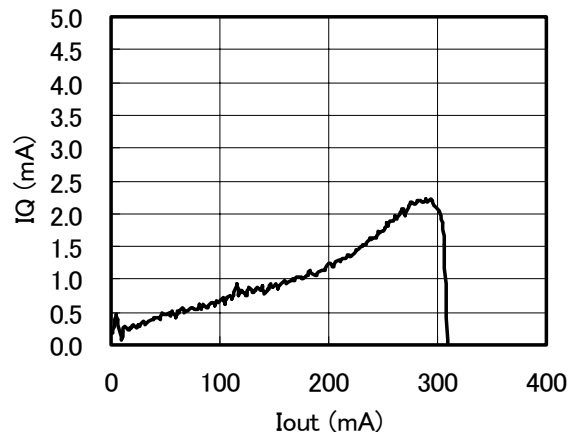
■ Load Regulation



■ Iout<sub>PEAK</sub>

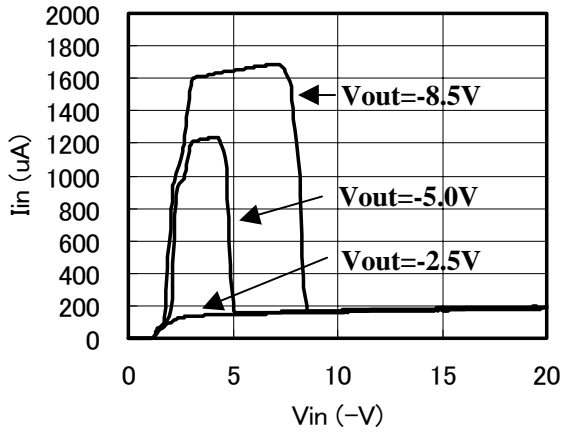


■ IQ

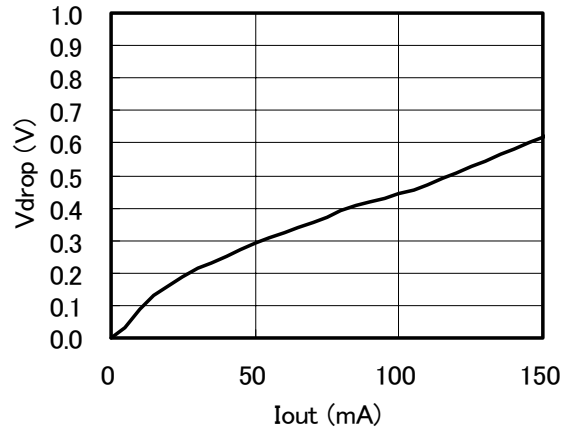


Unless otherwise specified  $V_{in}=V_{out\_TYP}-1.5V$ ,  $V_{cont}=0V$ ,  $C_{in}=1.0\mu F(MLCC)$ ,  $C_{out}=1.0\mu F(MLCC)$ ,  $C_{np}=0.01\mu F$   
 $T_a=25^\circ C$

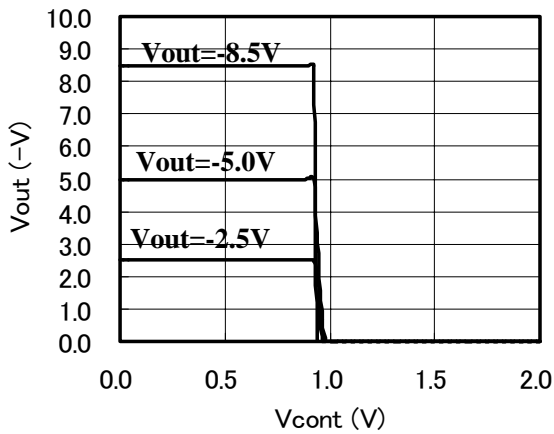
■ **Iin (Iout=0mA)**



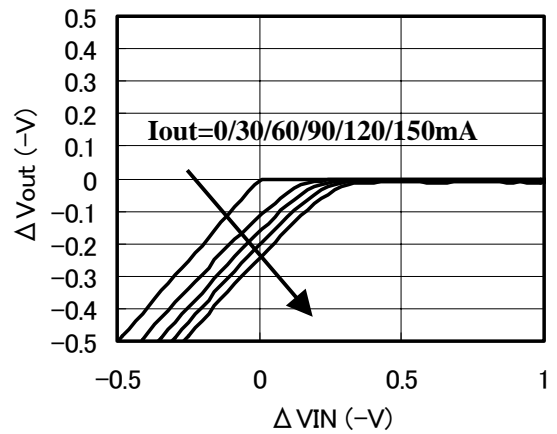
■ **Dropout Voltage**



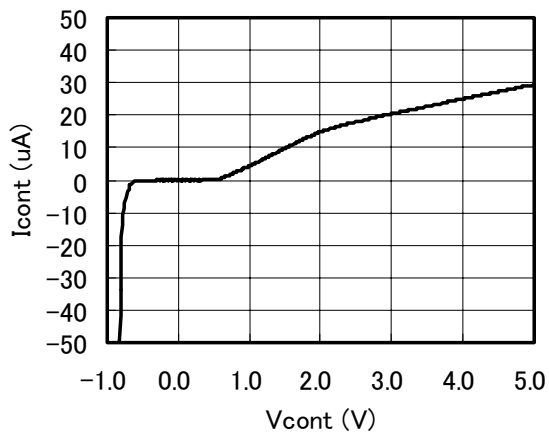
■ **Vout VS Vcont**



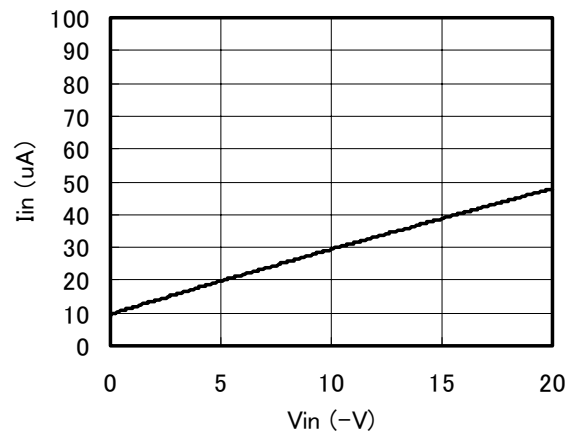
■ **Vout VS VIN**



■ **Icont VS Vcont (Iout=1mA)**



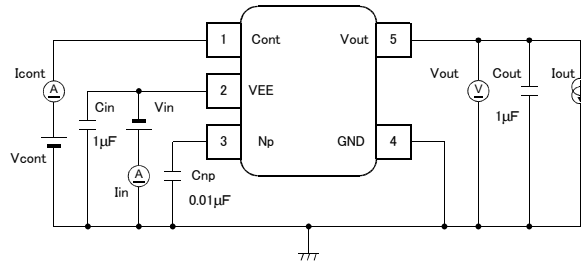
■ **Icc Off Mode (Vcont=1.5V, Iout=0mA)**



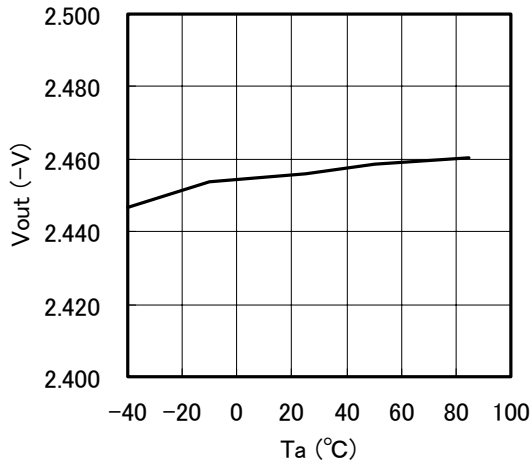


**10-2 Temperature characteristic**

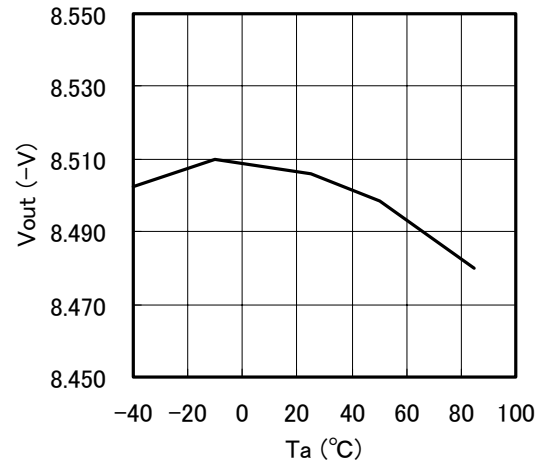
Unless otherwise specified  $V_{in} = -V_{out\_TYP} - 1.5V$ ,  $V_{cont} = 0V$ ,  $C_{in} = 1.0\mu F(MLCC)$ ,  $C_{out} = 1.0\mu F(MLCC)$ ,  $C_{np} = 0.01\mu F$



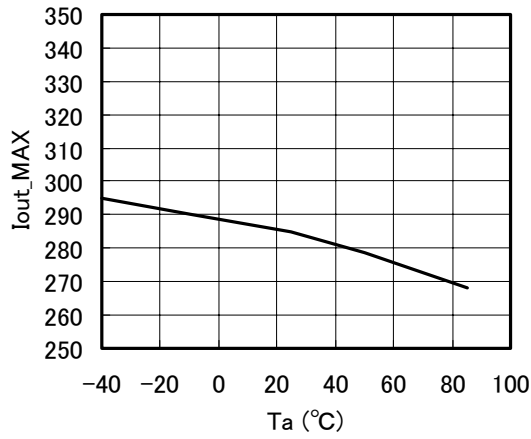
■ TK72125CS **Vout**



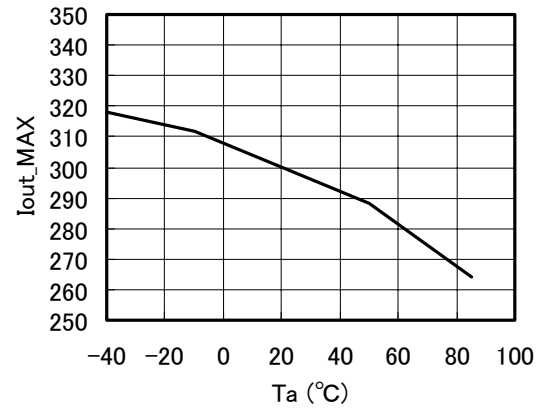
■ TK72185CS **Vout**



■ TK72125CS **Iout<sub>PEAK</sub>**

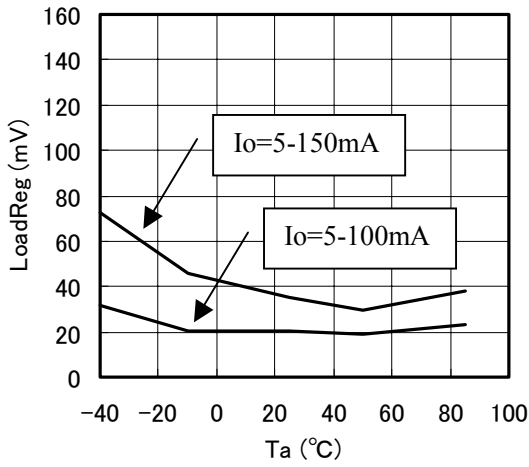


■ TK72185CS **Iout<sub>PEAK</sub>**

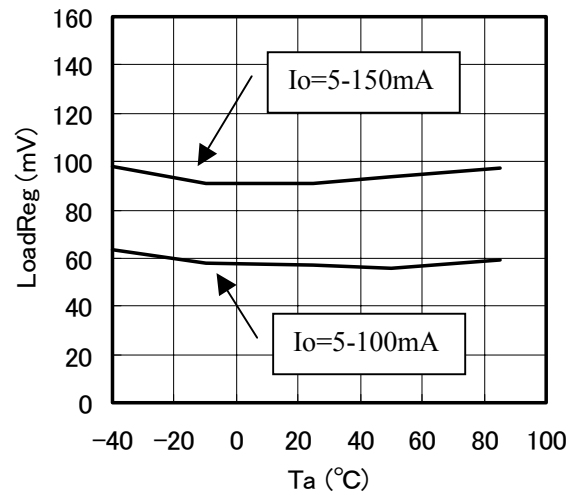


Unless otherwise specified  $V_{in} = -V_{out\_TYP} - 1.5V$ ,  $V_{cont} = 0V$ ,  $C_{in} = 1.0\mu F(MLCC)$ ,  $C_{out} = 1.0\mu F(MLCC)$ ,  $C_{np} = 0.01\mu F$

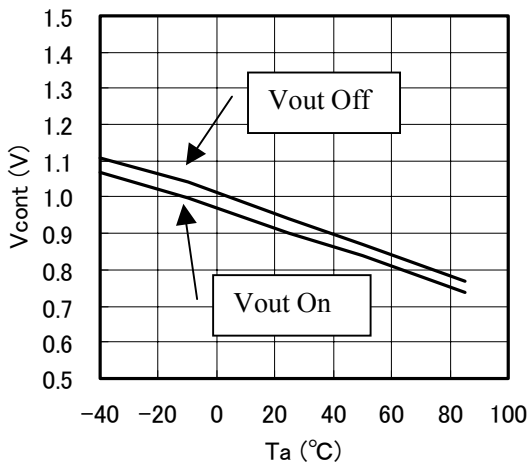
■ **TK72125CS LoadReg**



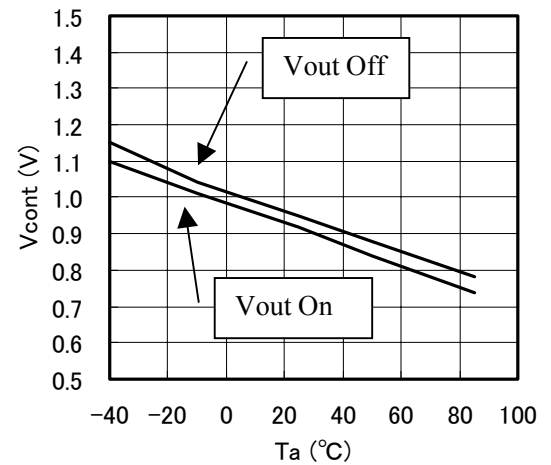
■ **TK72185CS LoadReg**



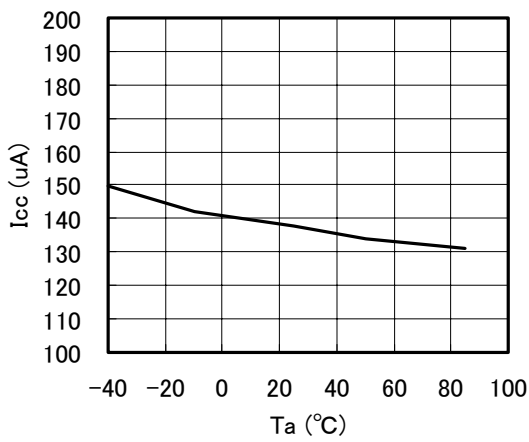
■ **TK72125CS ON/OFF**



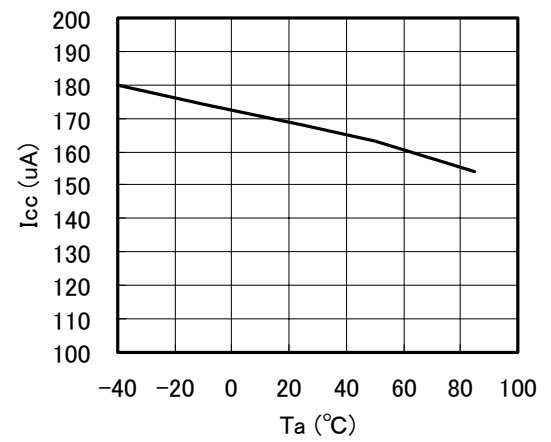
■ **TK72185CS ON/OFF**



■ **TK72125CS  $I_{in}(I_{out}=0mA)$**

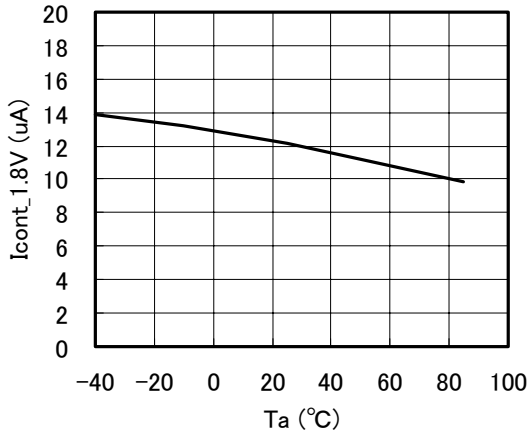


■ **TK72185CS  $I_{in}(I_{out}=0mA)$**

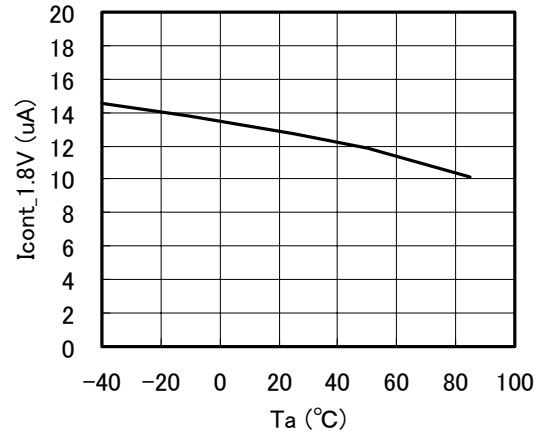


Unless otherwise specified  $V_{in} = -V_{out\_TYP} - 1.5V$ ,  $V_{cont} = 0V$ ,  $C_{in} = 1.0\mu F(MLCC)$ ,  $C_{out} = 1.0\mu F(MLCC)$ ,  $C_{np} = 0.01\mu F$

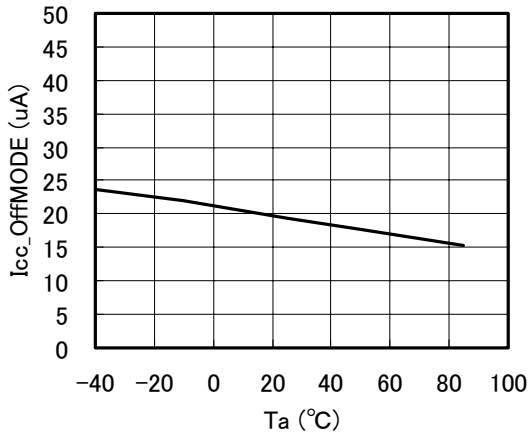
■ **TK72125CS Icont**



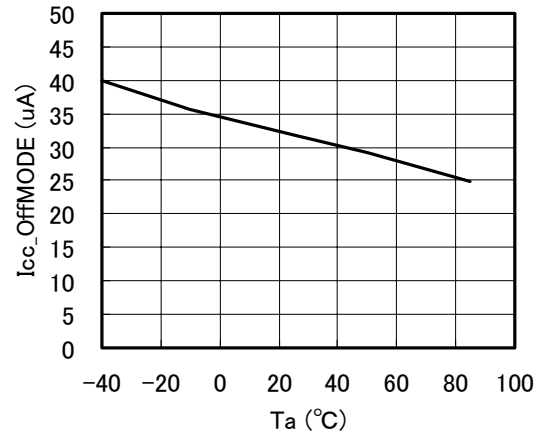
■ **TK72185CS Icont**



■ **TK72125CS Icc\_OFFMode**



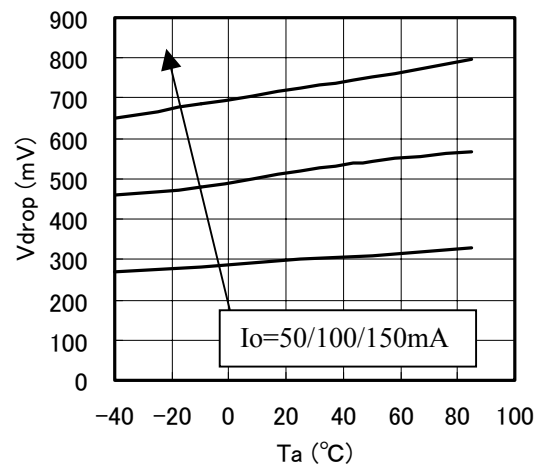
■ **TK72185CS Icc\_OFFMode**



■ **TK72125CS Vdrop**

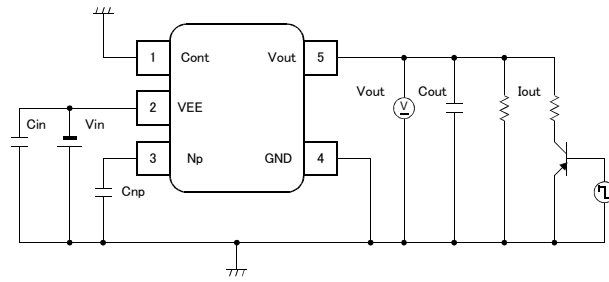
For  $V_{out} \geq -2.0V$ , no regulations

■ **TK72185CS Vdrop**



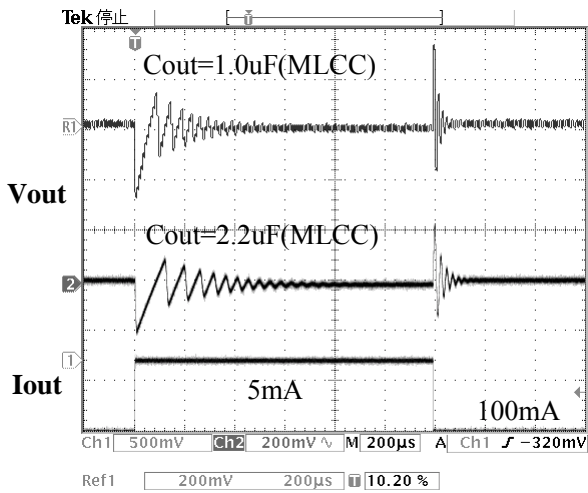
**10-3 Load Transient**

Unless otherwise specified  $V_{in}=V_{out,typ}-1.5V, C_{in}=1.0\mu F(MLCC), C_{np}=0.01\mu F$



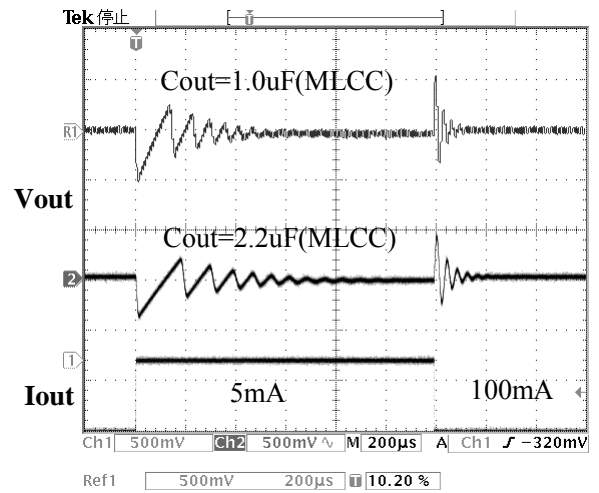
■TK72125CS

Vout:200mV/div Time:200usec/div



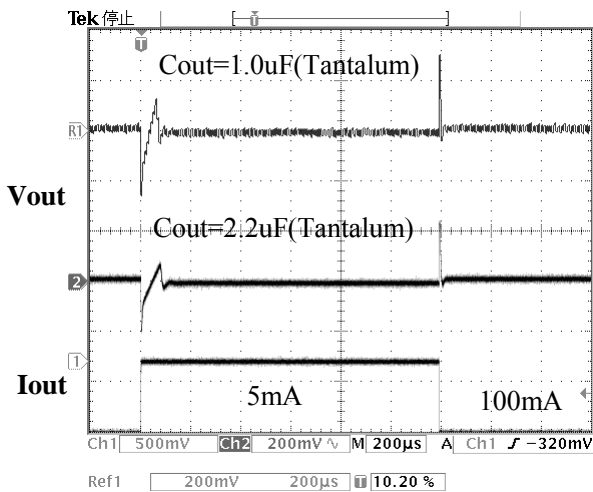
■TK72185CS

Vout:200mV/div Time:200usec/div



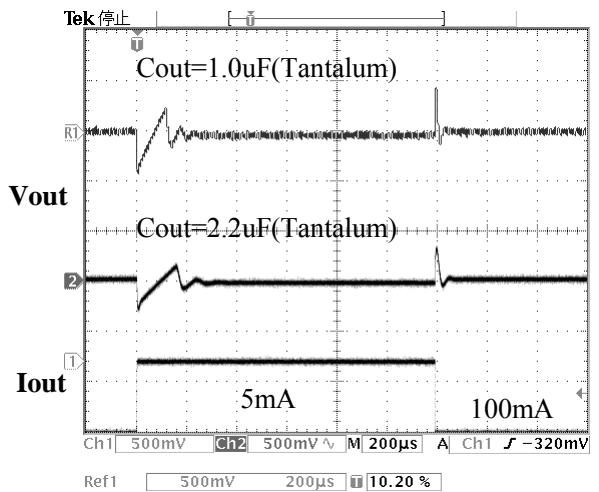
■TK72125CS

Vout:200mV/div Time:200usec/div



■TK72185CS

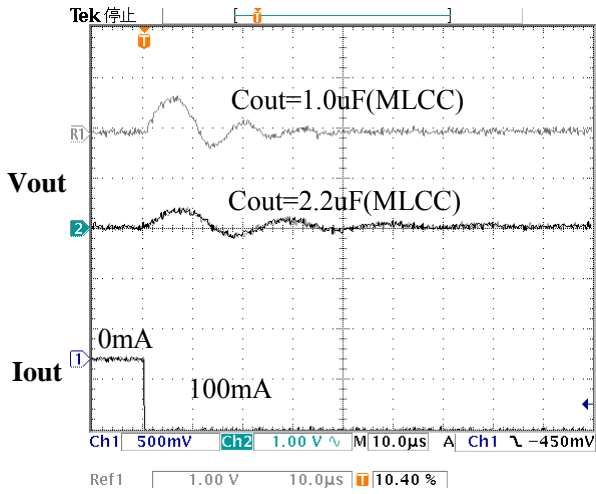
Vout:200mV/div Time:200usec/div



Unless otherwise specified  $V_{in}=V_{out\_TYP}-1.5V, C_{in}=1.0\mu F(MLCC), C_{np}=0.01\mu F$

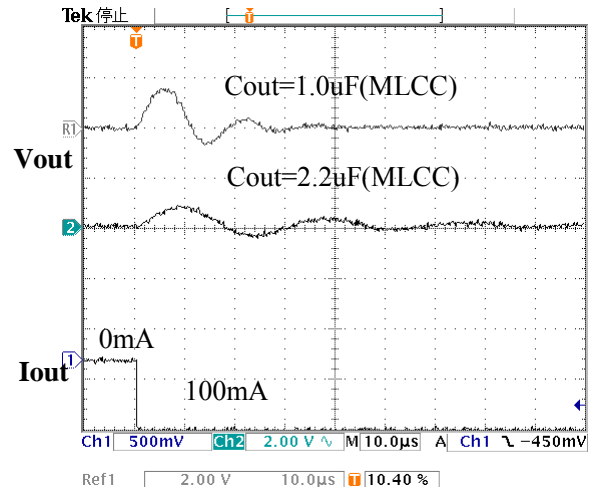
■TK72125CS

Vout:1V/div Time:10usec/div



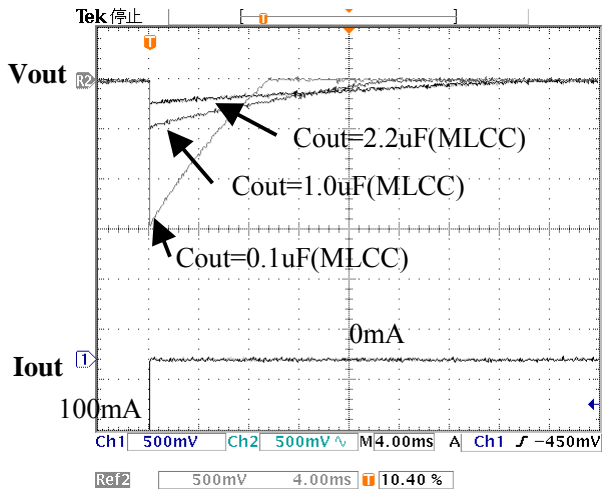
■TK72185CS

Vout:2V/div Time:10usec/div



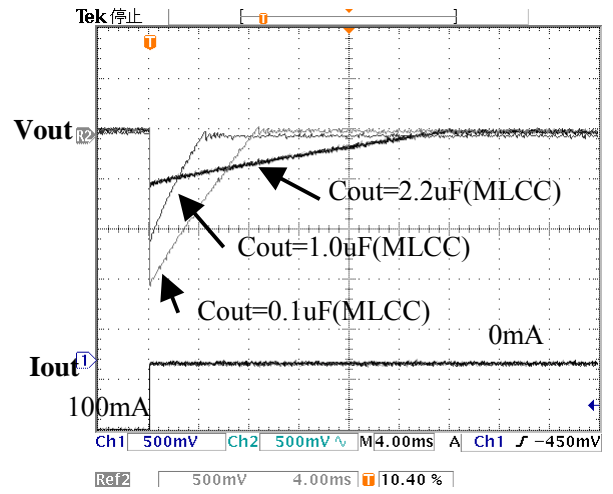
■TK72125CS

Vout:500mV/div Time:4msec/div



■TK72185CS

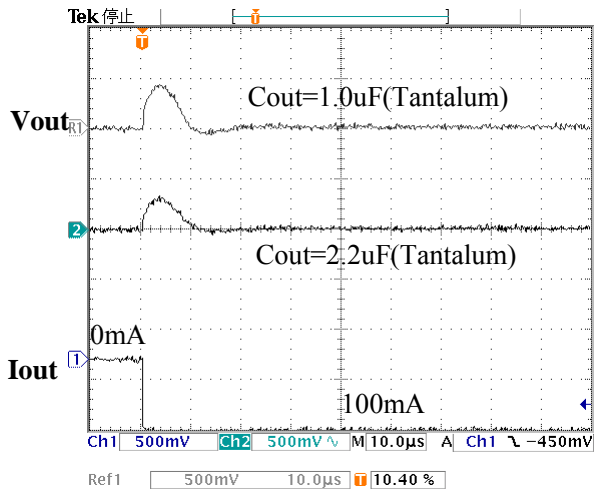
Vout:500mV/div Time:4msec/div



Unless otherwise specified  $V_{in}=V_{out\_TYP}-1.5V, C_{in}=1.0\mu F(MLCC), C_{np}=0.01\mu F$

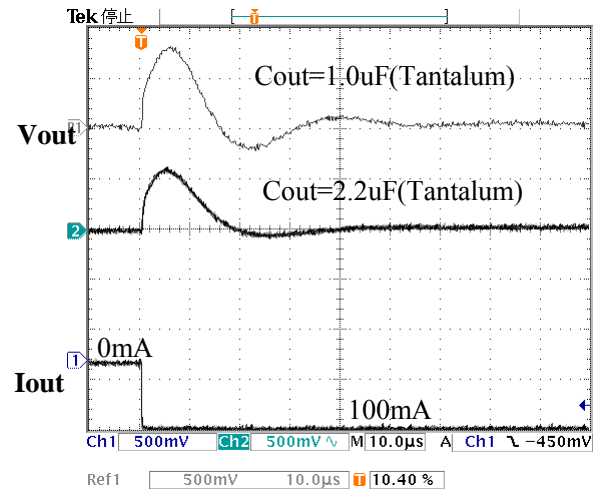
■TK72125CS

Vout:500mV/div Time:10usec/div



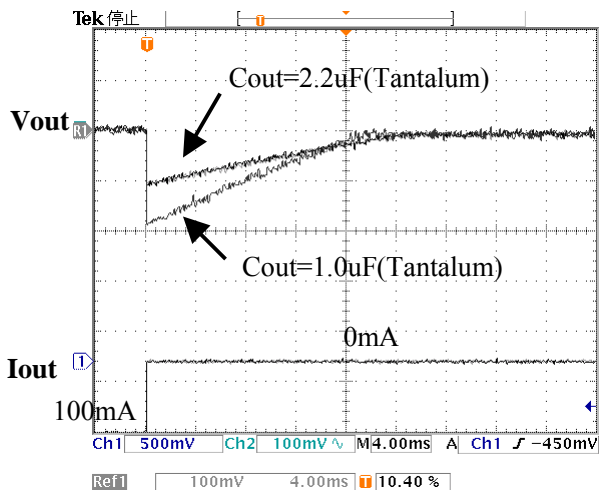
■TK72185CS

Vout:500mV/div Time:10usec/div



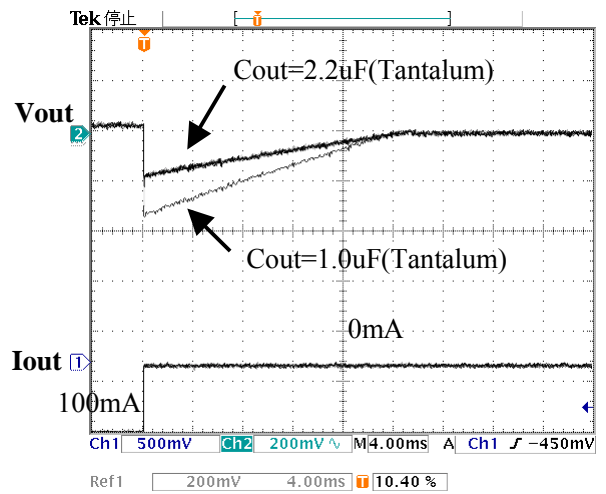
■TK72125CS

Vout:100mV/div Time:4msec/div



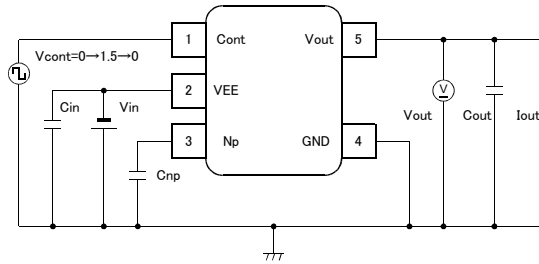
■TK72185CS

Vout:100mV/div Time:4msec/div

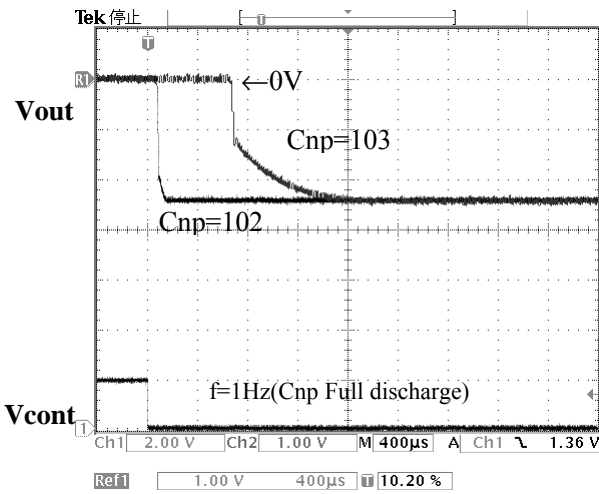


10-4 ON/OFF Transient

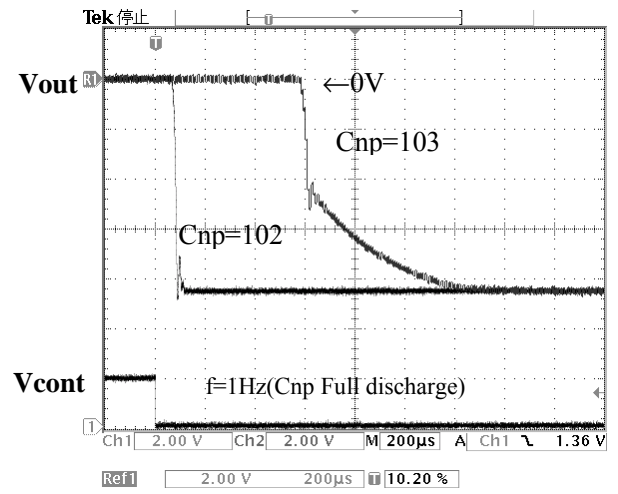
$V_{in}=V_{out\_TYP}-1.5V, C_{in}=1.0\mu F(MLCC), I_{out}=100mA$



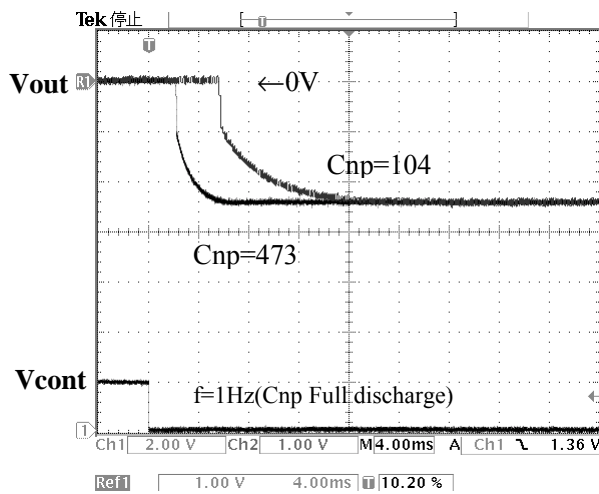
■TK72125CS  $C_{out}=1.0\mu F(MLCC)$   
 $V_{out}:1V/div$   $V_{cont}:2V/div$  Time:400usec/div



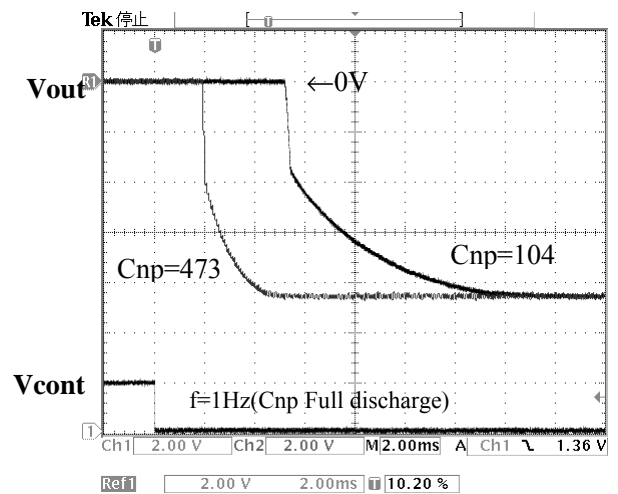
■TK72185CS  $C_{out}=1.0\mu F(MLCC)$   
 $V_{out}:2V/div$   $V_{cont}:2V/div$  Time:200usec/div



■TK72125CS  $C_{out}=1.0\mu F(MLCC)$   
 $V_{out}:1V/div$   $V_{cont}:2V/div$  Time:4msec/div



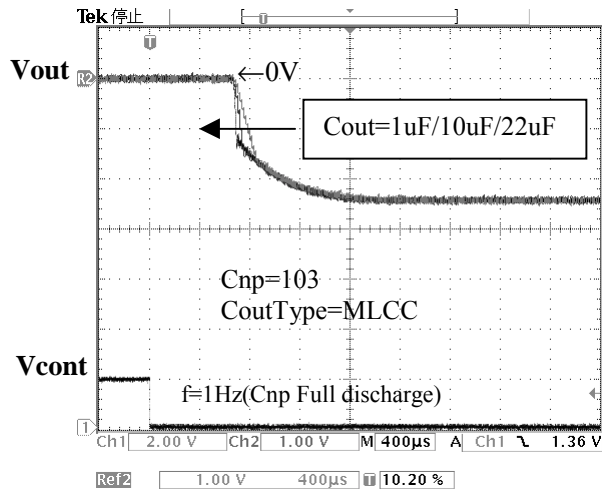
■TK72185CS  $C_{out}=1.0\mu F(MLCC)$   
 $V_{out}:2V/div$   $V_{cont}:2V/div$  Time:2msec/div



$V_{in} = -V_{out\_TYP} - 1.5V$ ,  $C_{in} = 1.0\mu F$  (MLCC),  $I_{out} = 100mA$

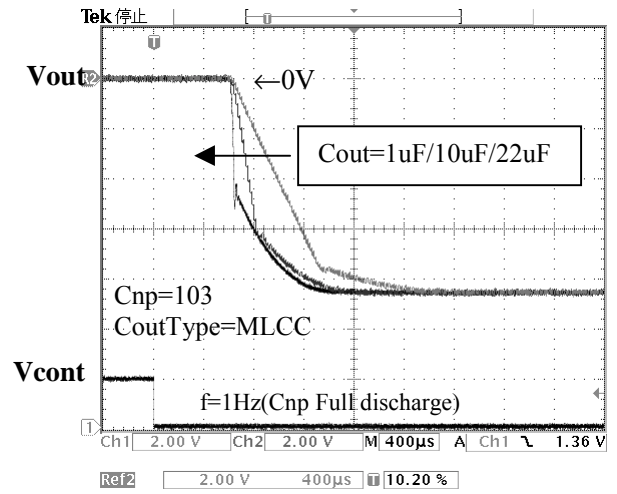
■TK72125CS

Vout:1V/div Vcont:2V/div Time:400usec/div



■TK72185CS

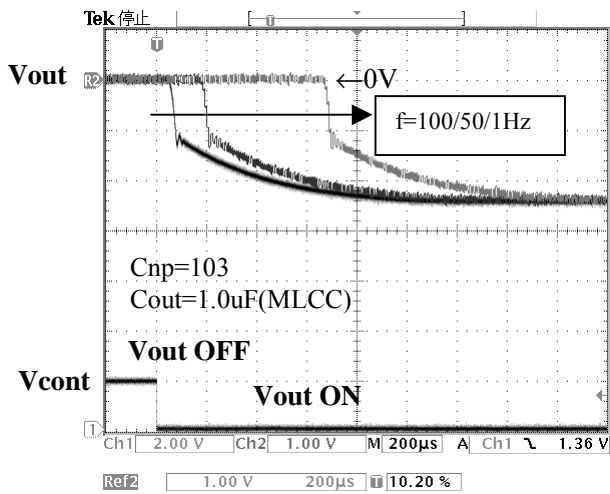
Vout:2V/div Vcont:2V/div Time:400usec/div



■TK72125CS

Control frequency variable

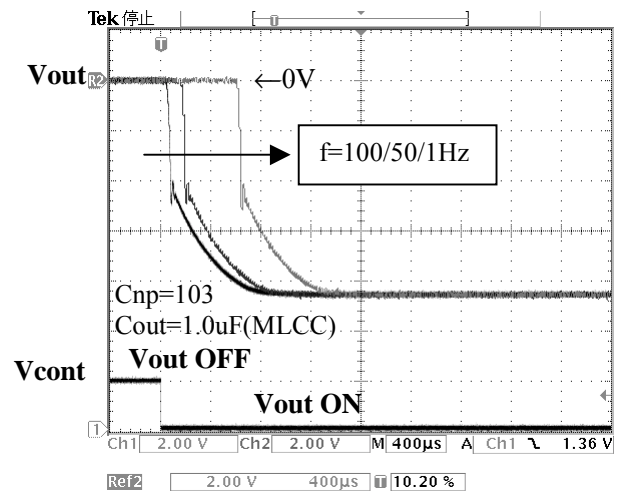
Vout:1V/div Vcont:2V/div Time:200usec/div



■TK72185CS

Control frequency variable

Vout:2V/div Vcont:2V/div Time:400usec/div



Rise-time of the output voltage. changes by Cout and Cnp.

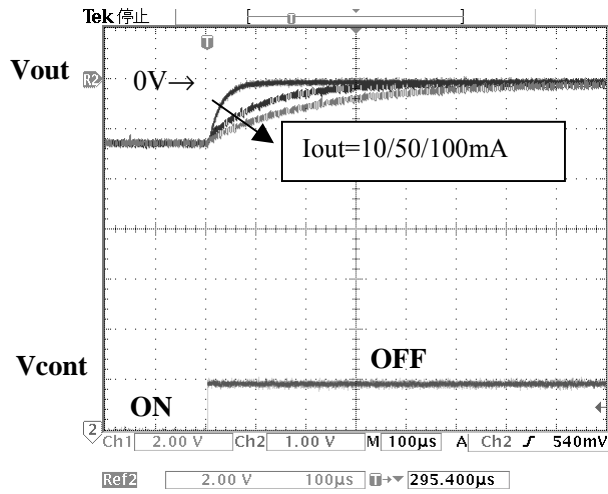
Moreover, the rise-time changes by the charge situation of Cnp. Standing up from the state that the charge came off completely slows most.



$V_{in} = -V_{out\_TYP} - 1.5V$ ,  $C_{in} = 1.0\mu F$  (MLCC),  $C_{out} = 1.0\mu F$  (MLCC),  $C_{np} = 0.01\mu F$ ,  $I_{out} = 100mA$

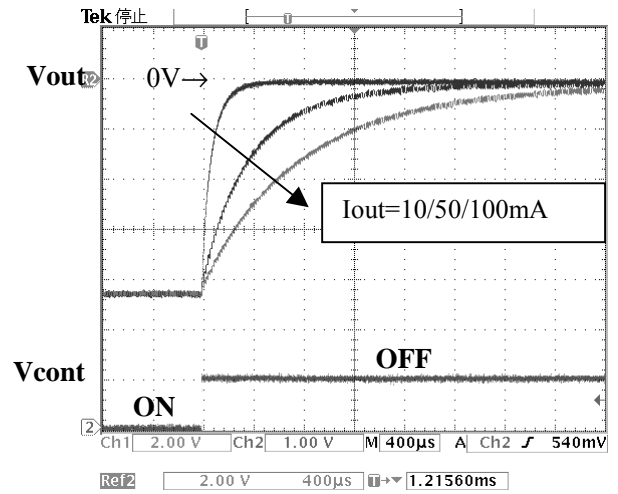
■TK72125CS

Vout:2V/div Vcont:1V/div Time:100usec/div



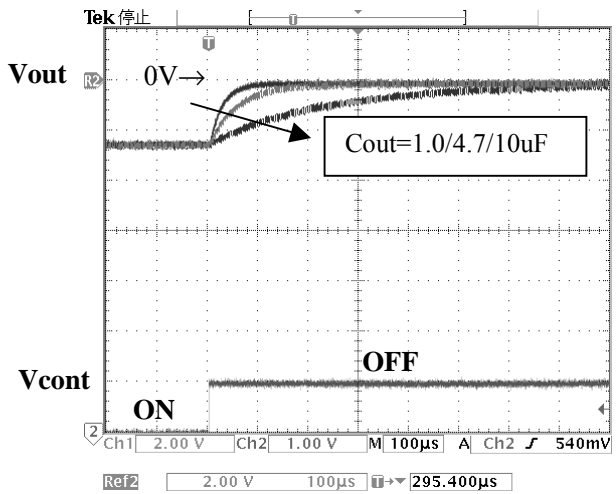
■TK72185CS

Vout:2V/div Vcont:1 V/div Time:400usec/div



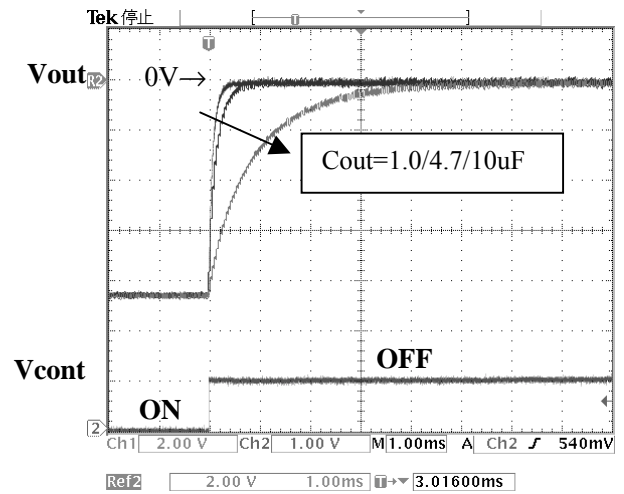
■TK72125CS

Vout:2V/div Vcont:1V/div Time:100usec/div



■TK72185CS

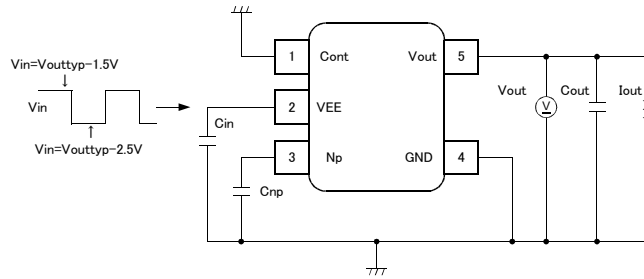
Vout:2V/div Vcont:1V/div Time:1msec/div



The turn on time will be largely affected by Iout and Cout, but not by Cnp.

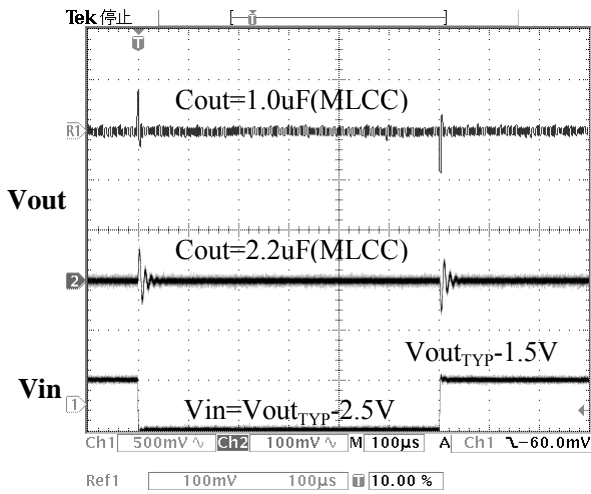
**10-5 Line Transient**

$V_{in} = -V_{out\_TYP} - 1.5 \rightarrow -V_{out\_TYP} - 2.5V$ ,  $C_{in} = 1.0\mu F(MLCC)$ ,  $C_{np} = 0.01\mu F$ ,  $I_{out} = 100mA$



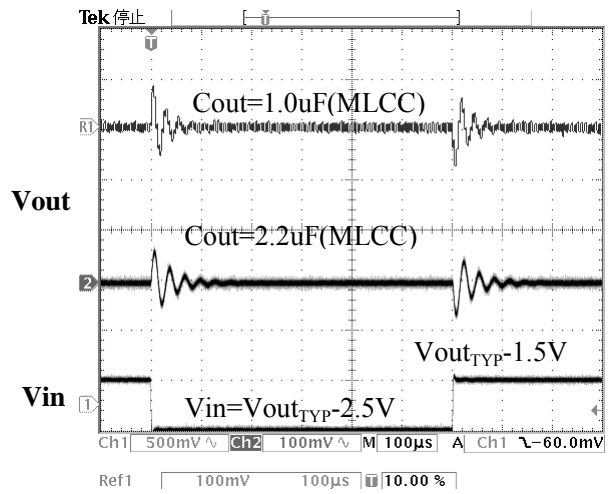
■TK72125CS

Vout:100mV/div Vin:1V/div Time:100usec/div



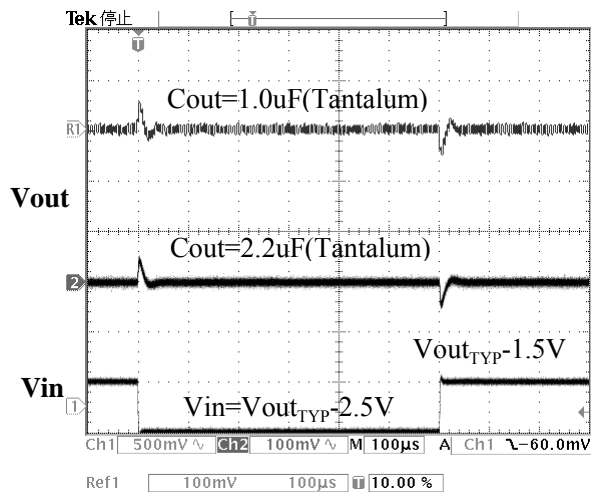
■TK72185CS

Vout:100mV/div Vin:1V/div Time:100usec/div



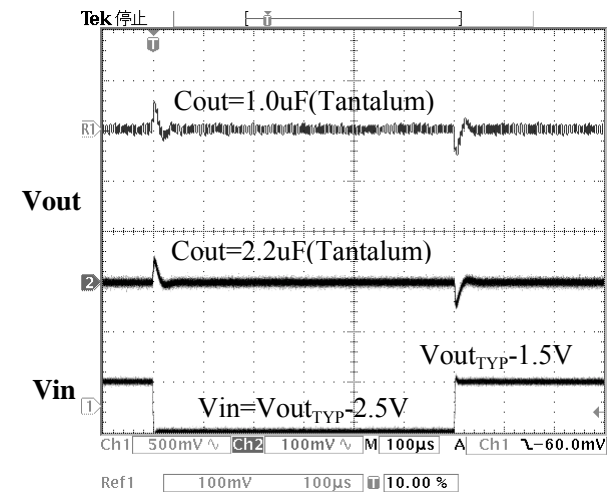
■TK72125CS

Vout:100mV/div Vin:1V/div Time:100usec/div



■TK72185CS

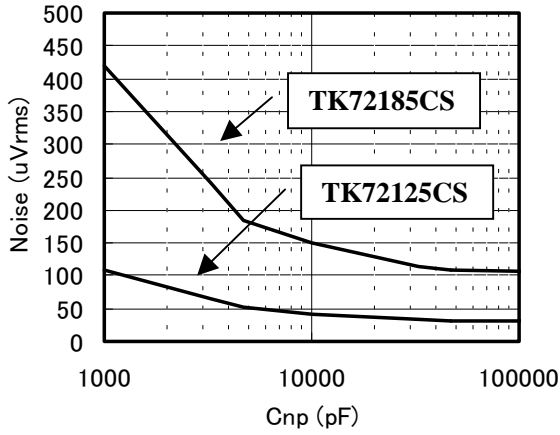
Vout:100mV/div Vin:1V/div Time:100usec/div



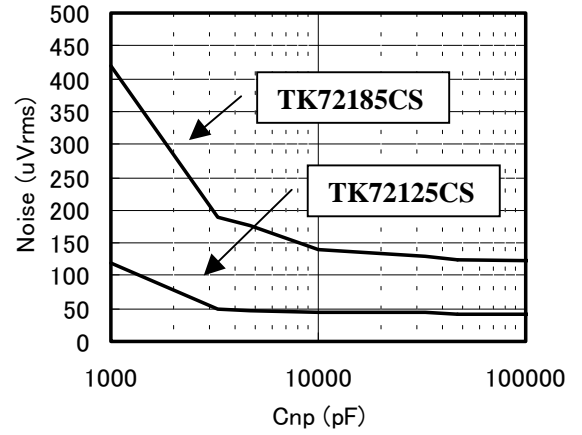
**10-6 Noise**

$V_{in} = V_{out\_TYP} - 1.5(V)$   $V_{cont} = 0V$   $C_{in} = 1.0\mu F(MLCC)$  BPF400 ~ 80kHz  $I_{out} = 100mA$

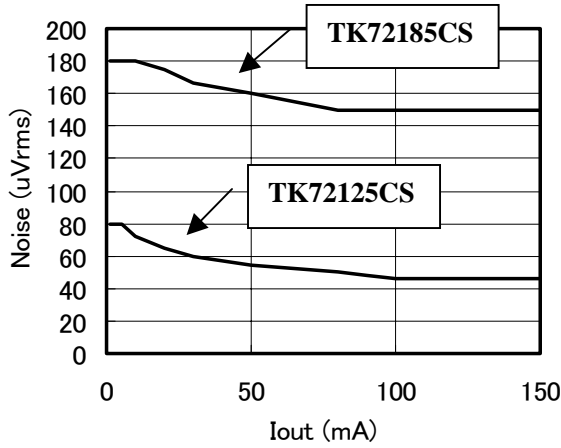
■  $C_{out} = 1.0\mu F(MLCC)$



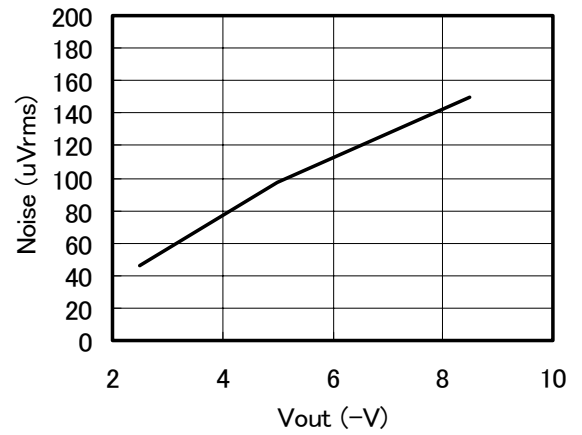
■  $C_{out} = 1.0\mu F(Tantalum)$



■  $C_{out} = 1.0\mu F(MLCC)$   $C_{np} = 103$

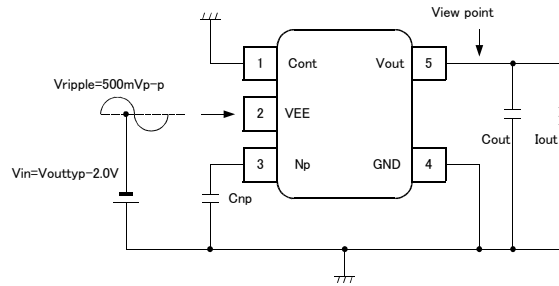


■  $C_{out} = 1.0\mu F(MLCC)$   $C_{np} = 103$   $I_{out} = 100mA$



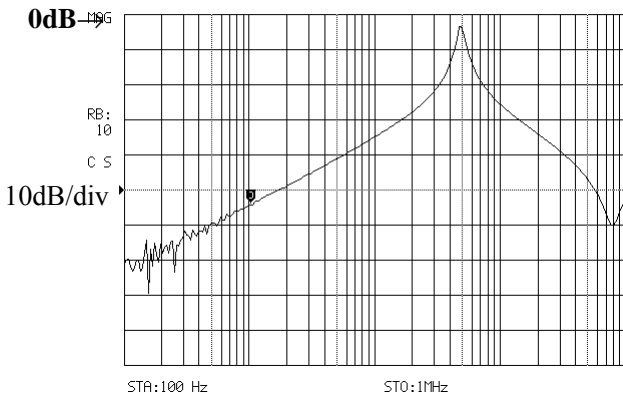
**10-7 Ripple Rejection**

$V_{in}=V_{out\_TYP}-2.0(V)$   $V_{ripple}=500mV_{p-p}$ ,  $C_{np}=0.01\mu F$ ,  $I_{out}=10mA$



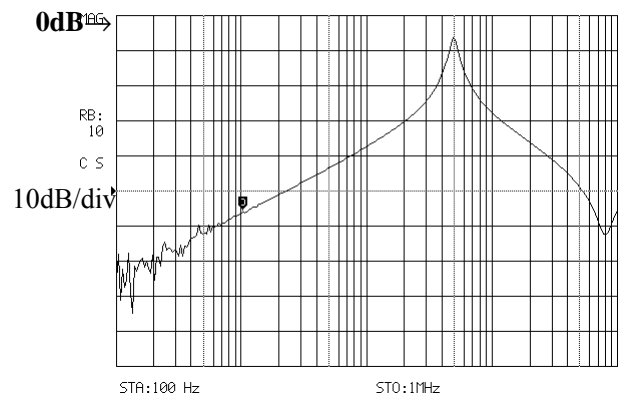
■TK72125CS  $C_{out}=1.0\mu F(MLCC)$

TA/R MK\_0 ( 63): -54.2884dB 10dB/ -50.000dB



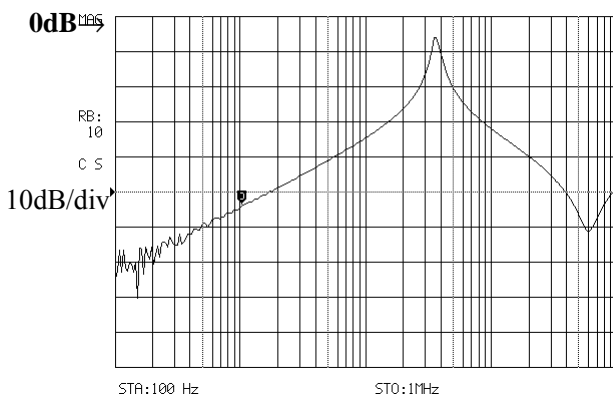
■TK72185CS  $C_{out}=1.0\mu F(MLCC)$

TA/R MK\_0 ( 63): -56.0447dB 10dB/ -50.000dB



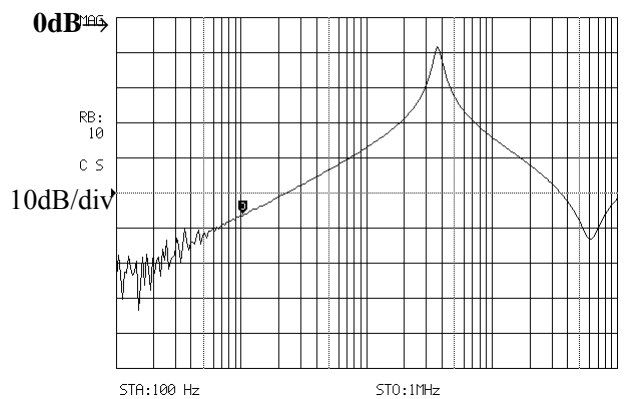
■TK72125CS  $C_{out}=2.2\mu F(MLCC)$

TA/R MK\_0 ( 63): -54.0675dB 10dB/ -50.000dB



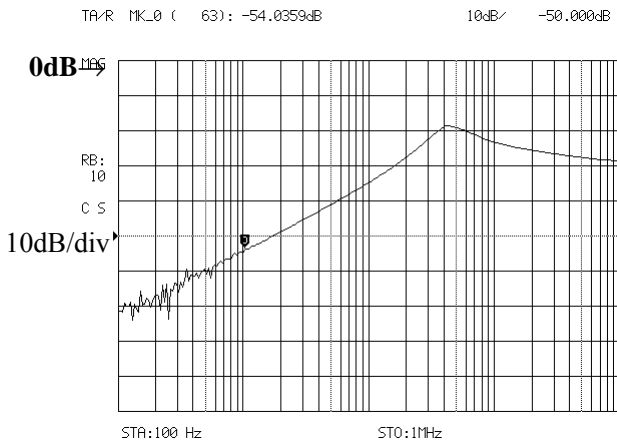
■TK72185CS  $C_{out}=2.2\mu F(MLCC)$

TA/R MK\_0 ( 63): -56.4507dB 10dB/ -50.000dB

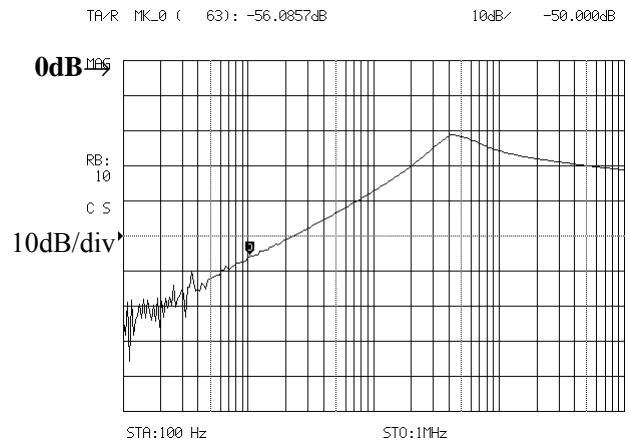


$V_{in} = V_{out\_TYP} - 2.0(V)$   $V_{ripple} = 500mV_{p-p}$ ,  $C_{np} = 0.01\mu F$ ,  $I_{out} = 10mA$

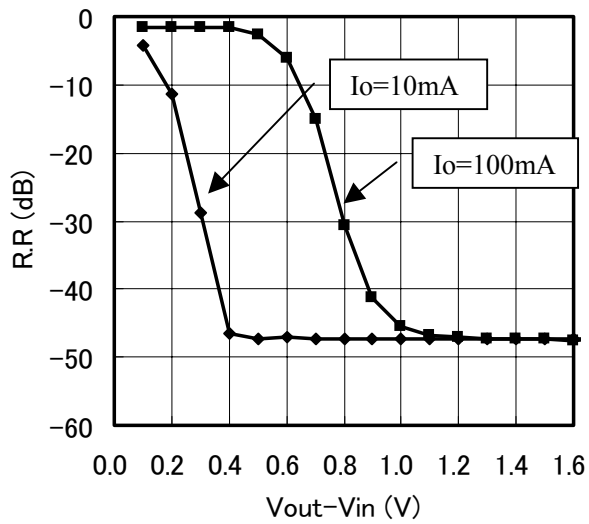
■TK72125CS  $C_{out} = 1.0\mu F$  (Tantalum)



■TK72185CS  $C_{out} = 1.0\mu F$  (Tantalum)



■TK721xxCS  $f = 1kHz$ ,  $V_{ripple} = 100mV_{p-p}$



**11. PIN DESCRIPTION**

Pin No	Pin Description	Internal Equivalent Circuit	Description
1	Cont		<p>ON/OFF control terminal Please do not apply -0.4V or less to this pin. The current might flow from GND.</p>
2	VEE	-	Input terminal
3	Np		Noise pass terminal
4	GND	-	GND terminal
5	Vout		<p>Output terminal</p> $V_{out} = V_{ref} \times \frac{R1 + R2}{R1}$

**12. APPLICATIONS INFORMATION**

**12-1. Definition of term**

**Relating Characteristic**

**note** Each characteristics will be measured in a short period not to be influenced by joint temperature ( $T_j$ ).

**\*Output voltage ( $V_{out}$ )**

The output voltage is specified with  $V_{in} = V_{out\_TYP} + 1V$  and  $I_{out} = 5mA$

**\*Output current ( $I_{out}$ )**

Output current, which can be used continuously (It is the range where overheating protection of the IC does not operate.)

**\*Peak output current ( $I_{out\_PEAK}$ )**

The rated output current is specified under the condition where the output voltage drops 90% by increasing the output current, compared to the value specified at  $V_{in} = V_{out\_TYP} - 1.5V$ .

**\*Dropout voltage ( $V_{drop}$ )**

It is an I/O voltage difference when the circuit stops the stable operation by decreasing the input voltage.

It is measured when the output voltage drops 100mV from its nominal value by decreasing the input voltage gradually.

**\*Line Regulation ( $LinReg$ )**

It is the fluctuations of the output voltage value when the input voltage is changed.

**\*Load Regulation ( $LoaReg$ )**

It is the fluctuations of output voltage value when the input voltage is assumed to be  $V_{out\_TYP} - 1.5V$ , and the load current is changed.

**\*Ripple Rejection (R.R)**

Ripple rejection is the ability of the regulator to attenuate the ripple content of the input voltage at the output. It is measured with the condition of  $V_{in} = V_{out} - 2.0V$ . Ripple rejection is the ratio of the ripple content between the output vs. input and is expressed in dB

**\*Standby current ( $I_{standby}$ )**

It is an input current which flows to the control terminal, when the IC is turned off.

**Relating Protection Circuit**

**\*Over Current Protection**

It is a function to protect the IC by limiting the output current when excessive current flows to IC, such as the output is connected to GND, etc.

**\*Thermal Protection**

It protects the IC not to exceed the permissible power consumption of the package in case of large power loss inside the regulator.

The output is turned off when the chip reaches around 150°C, but it turns on again when the temperature of the chip decreases.

**\*ESD**

It is tested by connecting charged capacitor to GND pin and  $V_{in}$  pin.

MM 200pF 0Ω 200Vmin  
HBM 100pF 1.5kΩ 2000Vmin

**12-2. ESR Stability**

IC does operates with 1.0uF Cout. If it is 1.0uF or larger, the capacitor of any type can be used in all range without considering ESR. But due to the parts are uneven, please enlarge the capacitance as much as possible. With larger capacity, the output noise decreases more. In addition, the response to the load change, etc. can be improved. The IC won't be damaged by enlarging the capacity.

The input capacitor is necessary in case the battery voltage drops, the power supply impedance increases, or the distance to the power supply is far. 1 input capacitor might be necessary for each 1 IC or for several ICs. It depends on circuit condition. Please confirm the stability by each circuit.

Generally, Multi layer ceramic capacitor (MLCC) has the temperature characteristic and the voltage characteristic. Please select parts in consideration of the voltage and the temperature used.

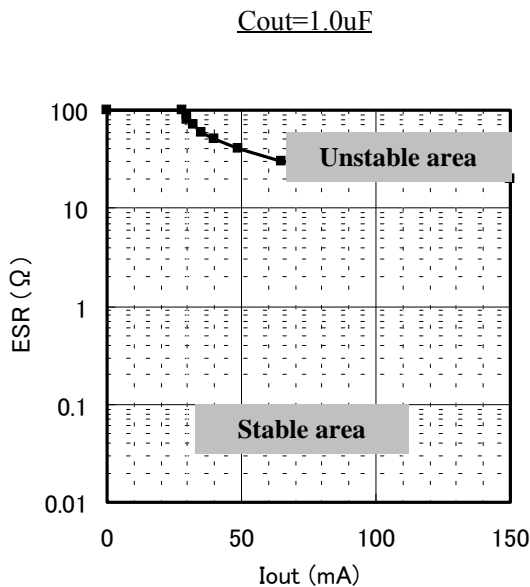
\*The output can be seen as oscillated when the overheating protection or the overcurrent protection start operation, or the input voltage is low. In this case, please lower the power consumption, decrease the load current or make the input voltage higher.

**Selection of Cout**

Generally, a ceramic capacitor has the temperature characteristic and the voltage characteristic. Please select parts in consideration of the voltage and the temperature used. TOKO recommend B characteristic type.

**Stability area graph (Vout=-2.0 ~ -9.5V)**

Condition: Vin=Vout<sub>typ</sub>-1.5V Cin=0.1μF(MLCC)





**12-3. Operating Region and Power Dissipation**

The power dissipation of the device is dependent on the junction temperature. Therefore, the package dissipation is assumed to be an internal limitation. The package itself does not have enough heat radiation characteristic due to the small size. Heat runs away by mounting IC on PCB. This value changes by the material, copper pattern etc. of PCB.

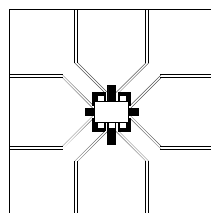
The overheating protection operates when there is a lot of loss inside the regulator (Ambient temperature high, heat radiation bad, etc.). The output current and the output voltage will drop when the protection circuit operates. When joint temperature (Tj) reaches the set temperature, IC stops the operation. However, operation begins at once when joint temperature(Tj) decrease.

**The thermal resistance when mounted on PCB**

The chip joint temperature during operation is shown by  $T_j = \theta_{ja} \times P_d + T_a$ . Joint part temperature (Tj) of TK721xxCS is limited around 150°C with the overheating protection circuit. Pd is the value when the overheating protection circuit starts operation.

When you assume the ambient temperature to be 25°C,  
 $150 = \theta_{ja} \times P_d (W) + 25$   
 $\theta_{ja} \times P_d = 125$   
 $\theta_{ja} = 125 / P_d (\text{°C} / W)$

**Example of mounting substrate**



PCB Material: Two layer glass epoxy substrate (x=30mm,y=30mm,t=1.0mm,Copper pattern thickness 35um)

Please do derating with 5.9mW/°C at Pd=736mW and 25°C or higher. Thermal resistance is ( $\theta_{ja} = 170\text{°C} / W$ )

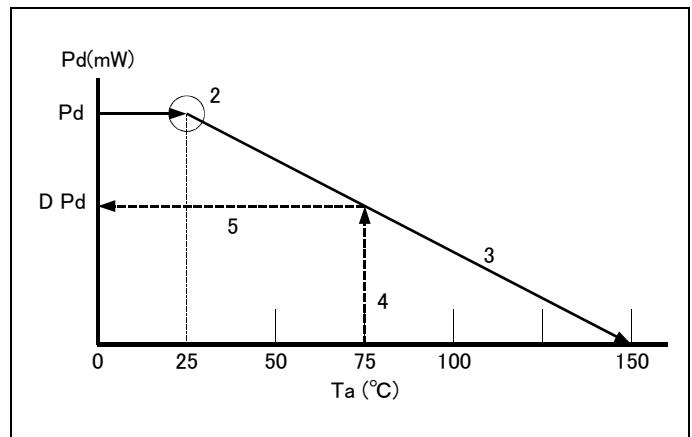
**Method of obtaining Pd easily**

Connect output terminal to GND(short circuited), and measure the input current by increasing the input voltage gradually up to 10V. The input current will reach the maximum output current, but will decrease soon according to the chip temperature rising, and will finally enter the state of thermal equilibrium (natural air cooling)

The input current and the input voltage of this state will be used to calculate the Pd.

$$P_d(mW) \cong V_{in} (V) \times I_{in} (mA)$$

When the device is mounted, mostly achieve 600mW or more.

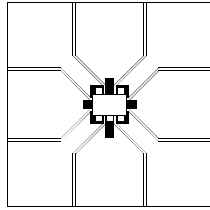


**Procedure (When mounted on PCB).**

1. Find Pd ( $V_{in} \times I_{in}$  when the output is short-circuited).
2. Plot Pd against 25°C.
3. Connect Pd to the point corresponding to the 150°C with a straight line.
4. Pull a vertical line from the maximum operating temperature in your design (e.g., 75°C).
5. Read the value of Pd against the point at which the vertical line intersects the derating curve(DPd).
6.  $DP_d \div (V_{inmax} - V_{out}) = I_{out}$  (at 75°C)

The maximum output current at the highest operating temperature will be  $I_{out} \cong DP_d \div (V_{inMax} - V_{out})$ . Please use the device at low temperature with better radiation. The lower temperature provides better quality.

**The operation area**



PCB Material : Two layer glass epoxy substrate  
 (x=30mm,y=30mm,t=1.0mm,Copper pattern thickness 35um)

Pd when mounted on the substrate mentioned above  
 (Ta=25°C)  
 SOT23-5=736mW (derating -5.9mW)

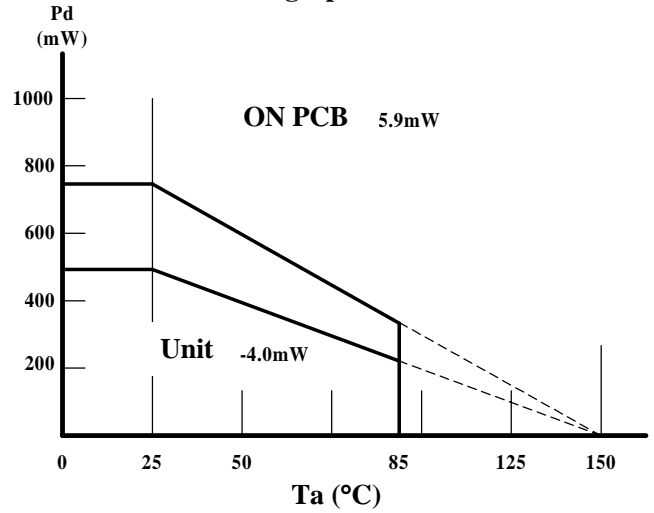
The current which can be used continuously with  
 Ta=25°C min is calculated by the following.

$$I_{out}(mA) = \frac{736 - 5.9 \times (Ta - 25)}{|V_{in}| - |V_{out}|} - \text{SOT23-5}$$

\*Iout<150mA

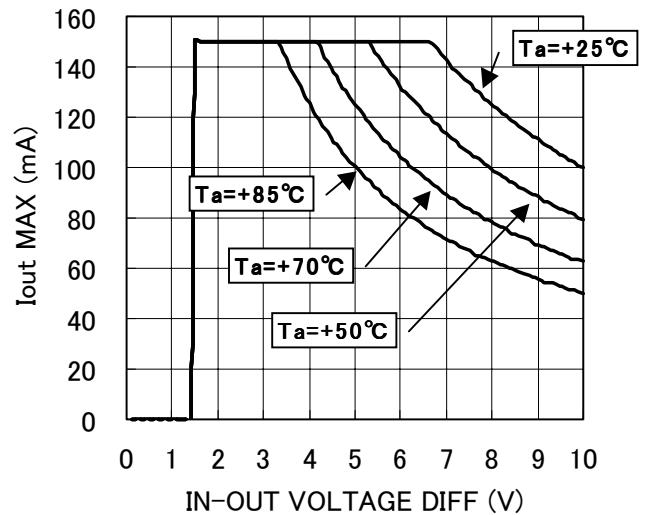
The operation area is the part enclosed in the line including the “0” mentioned in graph1  
 The overheating sensor may operate, or the output voltage may drop outside those area.  
 The heat radiation characteristic changes in various conditions, so please check under your condition.

**graph1**



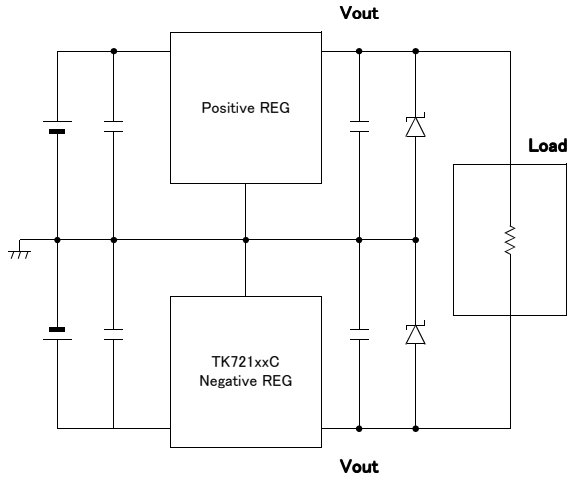
**graph2**

IoutMAX vs IN-OUT VOLTAGE DIFF (SOT23-5)



**12-4 Application hint**

**\*When using together with Positive output regulator**



When using positive output regulator together with this device, sometimes the voltage may not be outputted. To solve this problem, please connect Schottkey diode between GND and output, or change the timing of On/Off.

**\*When not using ON/OFF function**

Please connect the Cont terminal to GND.

**\*Notes when evaluating with output terminal is connected to GND(short-circuit)**

The output terminal becomes plus potential by the resonance of Cout (C element) connected to output and the short-circuit line (L element). When the output terminal becomes positive, parasitism Tr is caused inside the IC. The latch-up phenomenon occurs and in the worst case, IC may be damaged. ( $f_0 = 1 / 2\pi\sqrt{LC}$ )

This resonance appears remarkably when using a ceramic capacitor with small ESR, etc. This can be solved by connecting 2Ω resistance in series. As a result, the latch-up phenomenon in IC can be prevented.

Generally, tantalum capacitor has enough ESR value and the influence of the resonance decreases.

**13. NOTES**

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- Power drive products for automobile, ship or aircraft transport systems; steering and navigation systems, emergency signal communications systems, and any system other than those mentioned above which include electronic sensors, measuring, or display devices, and which could cause major damage to life, limb or property if misused or failure to function.

- Medical devices for measuring blood pressure, pulse, etc., treatment units such as coronary pacemakers and heat treatment units, and devices such as artificial organs and artificial limb systems which augment physiological functions.

- Electrical instruments, equipment or systems used in disaster or crime prevention.

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■ None of the ozone depleting substances(ODS) under the Montreal Protocol are used in our manufacturing process.

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